



Display Future Ltd

www.displayfuture.com

LCD MODULE SPECIFICATION

Model: DF-TFN0798FB-E1

This module uses ROHS materials

For customer acceptance

Customer		date
Approved		
Comments		

The standard product specification may change without prior notice in order to improve performance or quality. Please contact Display Future Ltd for updated specification and product status before design for the standard product or release of the order.

Revision	1.0
Engineering	
Date	2018/01/26
Our Reference	

1. SPECIFICATION

1.1 Display Specification

ITEM	STANDARD VALUE	UNIT
Display Format	800 (RGB) x 480 Dots	--
Display Connector	FPC	--
FPC Connector	50 Pin,0.5mm Pitch, SMD Horizontal Type Top contact	--
Operating Temperature	-20 ~ +70	°C
Storage Temperature	-30 ~ +80	°C
Touch Panel Optional	Yes	--
Sunlight Readable	No	--

1.2 Mechanical Specification

ITEM	STANDARD VALUE	UNIT
Diagonal Size	8.0	inch
Outline Dimension with FPC Folded	192.8(W) x116.9(H)	mm
Active Area	176.64(W) x 99.36(H)	mm
Pixel Size	0.0736(W) x 0.207(H)	mm
Gross Weight	368	g

1.3 Electrical Specification

ITEM	STANDARD VALUE	UNIT
IC Package	COG	--
Driver	OTA7001A_V03	--
Interface	RGB Interface	--
Response Time (Typ)	15	ms

1.4 Optical Specification

ITEM	STANDARD VALUE	UNIT
LCD Type	TFT-LCD / Transmissive / Positive	--
Viewing Angle Range	Left:70, Right:70, Up:50, Down:70	deg
Colors	65K/262K/16.7M	--
Contrast Ratio (Typ)	500:1	--
Brightness (Typ)	250	cd/m2

3. ELECTRICAL SPEC

3.1 Pin Configuration

Pin No	Symbol	Descriptions	
1	VLED+	Power for LED backlight (Anode)	
2	VLED+	Power for LED backlight (Anode)	
3	VLED-	Power for LED backlight (Cathode)	
4	VLED-	Power for LED backlight (Cathode)	
5	GND	Power ground	
6	VCOM	Common voltage	
7	DVDD	Power for Digital Circuit	
8	MODE	DE/SYNC mode select	Note 1
9	DE	Data Input Enable	
10	VS	Vertical Sync Input	
11	HS	Horizontal Sync Input	
12	B7	Blue data(MSB)	
13	B6	Blue data	
14	B5	Blue data	
15	B4	Blue data	
16	B3	Blue data	
17	B2	Blue data	
18	B1	Blue data	Note 2
19	B0	Blue data(LSB)	Note 2
20	G7	Green data(MSB)	
21	G6	Green data	
22	G5	Green data	
23	G4	Green data	
24	G3	Green data	
25	G2	Green data	
26	G1	Green data	Note 2
27	G0	Green data(LSB)	Note 2
28	R7	Red data(MSB)	
29	R6	Red data	
30	R5	Red data	
31	R4	Red data	
32	R3	Red data	
33	R2	Red data	
34	R1	Red data	Note 2
35	R0	Red data(LSB)	Note 2

36	GND	Power Ground	
37	DCLK	Sample clock	Note 3
38	GND	Power Ground	
39	L/R	Left / right selection	Note 4
40	U/D	Up/down selection	Note 4
41	VGH	Gate ON Voltage	
42	VGL	Gate OFF Voltage	
43	AVDD	Power for Analog Circuit	
44	RESET	Global reset pin.	Note 5
45	NC	No connection	
46	VCOM	Common Voltage	
47	DITHB	Dithering function	Note 6
48	GND	Power Ground	
49	NC	No connection	
50	NC	No connection	

Note 1: DE/SYNC mode select. Normally pull high.

When select DE mode, MODE="1", VS and HS can pull high or be ground.

When select SYNC mode, MODE="0", DE can pull high or be ground.

Note 2: When input 18 bits RGB data, the two low bits of R,G and B data must be grounded.

Note 3: Data shall be latched at the falling edge of DCLK.

Note 4: Selection of scanning mode

Setting of scan control input		Scanning direction
U/D	L/R	
GND	DVDD	Up to down, left to right
DVDD	GND	Down to up, right to left
GND	GND	Up to down, right to left
DVDD	DVDD	Down to up, left to right

Note 5: Global reset pin. Active low to enter reset state. Suggest to connect with an RC reset circuit for stability. Normally pull high.

Note 6: Dithering function enable control, normally pull high.

When DITHB=" 1" ,Disable internal dithering function,

When DITHB=" 0" ,Enable internal dithering function.

3.2 Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Power Supply Voltage	VCC	-0.3	-	+5.0	V
Operating Temperature	Top	-30	-	+85	° C
Storage Temperature	TST	-30	-	+85	° C
Humidity	RH	-		90%(Max60° C)	RH

3.3 Electrical Characteristics

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Power Supply Voltage	VCC	3.0	3.3	3.6	V
	AVDD	10.2	10.4	10.6	V
	VGH	15.3	16.0	16.7	V
	VGL	-7.7	-7	-6.3	V
	VCOM	3.4	4.4	5.4	V
Input Voltage'H'Level	VIH	0.7*VCC	-	VCC	V
Input Voltage'L'Level	VIL	0	-	0.3VCC	V
Backlight Forward Voltage	VLED	9.0	9.6	10.2	V
Backlight Current	ILED	180	200	224	mA

I. INSPECTION CRITERIA

I.1 Acceptable Quality Level

Each lot should satisfy the quality level defined as follows

PARTITION	AQL	DEFINITION
A. Major	0.4%	Functional defective as product
B. Minor	1.5%	Satisfy all functions as product but not satisfy cosmetic standard

I.2 Definition of Lot

One lot means the delivery quantity to customer at one time.

I.3 Condition of Cosmetic Inspection

◆ INSPECTION AND TEST

- FUNCTION TEST
- APPEARANCE INSPECTION
- PACKING SPECIFICATION

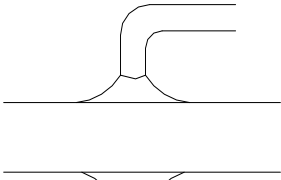
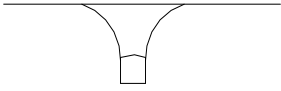
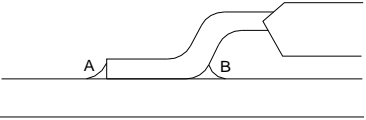
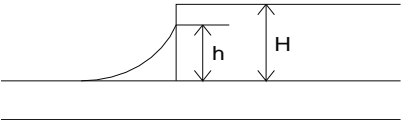
◆ INSPECTION CONDITION

- Put under the lamp (20W) at a distance 100mm from
- Tilt upright 45 degree by the front (back) to inspect LCD appearance.

◆ AQL INSPECTION LEVEL

- SAMPLING METHOD: MIL-STD-105D
- SAMPLING PLAN: SINGLE
- MAJOR DEFECT: 0.4% (MAJOR)
- MINOR DEFECT: 1.5% (MINOR)
- GENERAL LEVEL: II/NORMAL

I.4 Module Cosmetic Criteria

NO.	Item	Judgment Criterion	Partition
1	Difference in Spec.	None allowed	Major
2	Pattern Peeling	No substrate pattern peeling and floating	Major
3	Soldering defects	No soldering missing	Major
		No soldering bridge	Major
		No cold soldering	Minor
4	Resist flaw on substrate	Invisible copper foil(\varnothing 0.5mm or more)on substrate pattern	Minor
5	Accretion of metallic Foreign matter	No soldering dust	Minor
		No accretion of metallic foreign matters(Not exceed \varnothing 0.2mm)	
6	Stain	No stain to spoil cosmetic badly	Minor
7	Plate discoloring	No plate fading,rusting and discoloring	Minor
8	Solder amount 1.Lead parts	<p>a. Soldering side of PCB</p> <p>Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.(too much)</p>  <p>b.Components side (In case of 'Through Hole PCB')</p> <p>Solder to reach the Components side of PCB</p> 	Minor
	2.Flat packages	<p>Either 'toe'(A) or 'heel' (B) of the lead to be covered by 'Filet'</p>  <p>Lead form to be assume over Solder.</p>	Minor
	3.Chips	<p>$(3/2) H \geq h \geq (1/2)H$</p> 	Minor

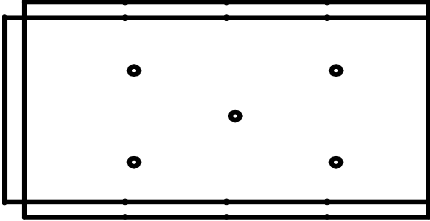
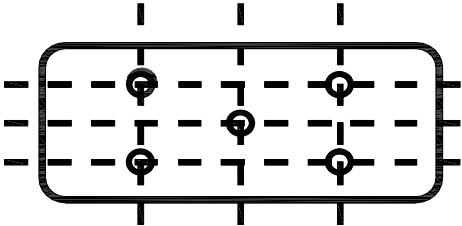
9	Backlight defects	<ol style="list-style-type: none"> 1. Light fails or flickers.(Major) 2. Color and luminance do not correspond to specifications. (Major) 3.Exceeds standards for display's blemishes, foreign matter, dark lines or scratches.(Minor) 	<p>See list ←</p>
10	PCB defects	<ol style="list-style-type: none"> 1. Oxidation or contamination on connectors.* 2. Wrong parts, missing parts, or parts not in specification.* 3.Jumpers set incorrectly.(Minor) 4.Solder(if any)on bezel,LED pad,zebra pad,or screw hole pad is not smooth.(Minor) <p>*Minor if display functions correctly.Major if the display fails.</p>	<p>See list ←</p>
11	Soldering defects	<ol style="list-style-type: none"> 1. Unmelted solder paste. 2. Cold solder joints,missing solder connections,or oxidation.* 3. Solder bridges causing short circuits.* 4. Residue or solder balls. 5. Solder flux is black or brown. <p>*Minor if display functions correctly. Major if the display fails.</p>	<p>Minor</p>

I.5 Screen Cosmetic Criteria (Non-Operating)

No.	Defect	Judgment Criterion	Partition	
1	Spots	In accordance with Screen Cosmetic Criteria (Operating) No.1.	Minor	
2	Lines	In accordance with Screen Cosmetic Criteria (Operation) No.2.	Minor	
3	Bubbles in Polarizer		Minor	
		Size: d mm		Acceptable Qty in active area
		d ≤ 0.3		Disregard
		0.3 < d ≤ 1.0		3
1.0 < d ≤ 1.5	1			
1.5 < d	0			
4	Scratch	In accordance with spots and lines operating cosmetic criteria, When the light reflects on the panel surface, the scratches are not to be remarkable.	Minor	
5	Allowable density	Above defects should be separated more than 30mm each other.	Minor	
6	Coloration	Not to be noticeable coloration in the viewing area of the LCD panels. Back-lit type should be judged with back-lit on state only.	Minor	
7	Contamination	Not to be noticeable.	Minor	

I.6 Screen Cosmetic Criteria (Operating)

No.	Defect	Judgment Criterion	Partition	
1	Spots	A) Clear	Minor	
		Size:d mm		Acceptable Qty in active area
		$d \leq 0.1$ $0.1 < d \leq 0.2$ $0.2 < d \leq 0.3$ $0.3 < d$		Disregard 6 2 0
		Note: Including pin holes and defective dots which must be within one pixel Size.		
		B) Unclear		Minor
		Size:d mm		
$d \leq 0.2$ $0.2 < d \leq 0.5$ $0.5 < d \leq 0.7$ $0.7 < d$	Disregard 6 2 0			
2	Lines	A) Clear	Minor	
		<p>Note: () – Acceptable Qty in active area L - Length (mm) W -Width(mm) ∞-Disregard</p>		
		B) Unclear		
<p>'Clear' = The shade and size are not changed by Vo. 'Unclear' = The shade and size are changed by Vo.</p>				

No.	Defect	Judgment Criterion	Partition
3	Rubbing line	Not to be noticeable.	
4	Allowable density	Above defects should be separated more than 10mm each other.	Minor
5	Rainbow	Not to be noticeable.	Minor
6	Dot size	To be 95%~105%of the dot size (Typ.) in drawing. Partial defects of each dot (ex.pin-hole) should be treated as'spot'. (see Screen Cosmetic Criteria (Operating) No.1)	Minor
7	Brightness (only back-lit Module)	Brightness Uniformity must be $B_{MAX}/B_{MIN} \leq 2$ - B_{MAX} :Max.value by measure in 5 points - B_{MIN} : Min.value by measure in 5 points Divide active area into 4 vertically and horizontally. Measure 5 points shown in the following figure. 	Minor
8	Contrast Uniformity	Contrast Uniformity must be $B_{mAX}/B_{mIN} \leq 2$ Measure 5 points shown in the following figure. Dashed lines divide active area into 4 vertically and horizontally. Measuring points are located at the inter-sections of dashed line.  Note: B_{MAX} – Max.value by measure in 5 points. B_{MIN} – Min.value by measure in 5 points. O – Measuring points in $\phi 10mm$.	Minor

Note:

- (1) Size : $d=(\text{long length} + \text{short length})/2$
- (2) The limit samples for each item have priority.
- (3) Complexed defects are defined item by item, but if the number of defects is defined in above table, the total number should not exceed 10.

(4) In case of 'concentration', even the spots or the lines of 'disregarded' size should not be allowed. Following three situations

Should be treated as 'concentration'.

- 7 or over defects in circle of \varnothing 5mm.
- 10 or over defects in circle of \varnothing 10mm
- 20 or over defects in circle of \varnothing 20mm

II. PRECAUTIONS FOR USING

II.1 Handling Precautions

- ◆ This device is susceptible to Electro-Static Discharge (ESD) damage. Observe Anti-Static precautions.
- ◆ Display Future display panel is made of glass. Do not subject it to a mechanical shock by dropping it or impact.
- ◆ If Display Future display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- ◆ Do not apply excessive force to the Display Future display surface or the adjoining areas since this may cause the color tone to vary.
- ◆ The polarizer covering the Display Future display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- ◆ If Display Future display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following Isopropyl or alcohol.
- ◆ Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the Water.
- ◆ Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- ◆ Install the Display Future LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the cable or the backlight cable.
- ◆ Do not attempt to disassemble or process Display Future LCD module.
- ◆ NC terminal should be open. Do not connect anything.
- ◆ If the logic circuit power is off, do not apply the input signals.
- ◆ To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling Display Future LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

II.2 Power Supply Precautions

- ◆ Identify and, at all times, observe absolute maximum ratings for both logic and LC drivers. Note that there is some variance between models.
- ◆ Prevent the application of reverse polarity to VDD and VSS, however briefly.
- ◆ Use a clean power source free from transients. Power-up conditions are occasionally jolting and may exceed the maximum ratings of Display Future modules.
- ◆ The VDD power of Display Future module should also supply the power to all devices that may access the display. Don't allow the data bus to be driven when the logic supply to the module is turned off.

II.3 Operating Precautions

- ◆ DO NOT plug or unplug Display Future module when the system is powered up.
- ◆ Minimize the cable length between Display Future module and host MPU.
- ◆ For models with backlights, do not disable the backlight by interrupting the HV line. Unload inverters produce voltage extremes that may arc within a cable or at the display.
- ◆ Operate Display Future module within the limits of the modules temperature specifications.

II.4 Mechanical/Environmental Precautions

- ◆ Improper soldering is the major cause of module difficulty. Use of flux cleaner is not recommended as they may seep under the electrometric connection and cause display failure.
- ◆ Mount Display Future module so that it is free from torque and mechanical stress.
- ◆ Surface of the LCD panel should not be touched or scratched. The display front surface is an easily scratched, plastic polarizer. Avoid contact and clean only when necessary with soft, absorbent cotton dampened with petroleum benzene.
- ◆ Always employ anti-static procedure while handling Display Future module.
- ◆ Prevent moisture build-up upon the module and observe the environmental constraints for storage tem
- ◆ Do not store in direct sunlight
- ◆ If leakage of the liquid crystal material should occur, avoid contact with this material, particularly ingestion. If the body or clothing becomes contaminated by the liquid crystal material, wash thoroughly with water and soap

II.5 Storage Precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

Keep Display Future modules in bags (avoid high temperature / high humidity and low temperatures below 0C. Whenever possible, Display Future LCD modules should be stored in the same conditions in which they were shipped from our company.

II.6 Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If Display Future LCD modules have been operating for a long time showing the same display patterns, the

display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- Terminal electrode sections.

III. USING LCD MODULES

III.1 Liquid Crystal Display Modules

Display Future LCD is composed of glass and polarizer. Pay attention to the following items when handling.

- ◆ Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.
- ◆ Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.).
- ◆ N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.
- ◆ When Display Future display surface becomes dusty, wipe gently with absorbent cotton or other soft material like chamois soaked in petroleum benzine. Do not scrub hard to avoid damaging the display surface.
- ◆ Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.
- ◆ Avoid contacting oil and fats.
- ◆ Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming in contact with room temperature air.
- ◆ Do not put or attach anything on Display Future display area to avoid leaving marks on.
- ◆ Do not touch the display with bare hands. This will stain the display area and degrade insulation between terminals (some cosmetics are determined to the polarizers).
- ◆ As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring.

III.2 Installing LCD Modules

- ◆ Cover the surface with a transparent protective plate to protect the polarizer and LC cell.
- ◆ When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be $\pm 0.1\text{mm}$.

III.3 Precaution for Handling LCD Modules

Since Display Future LCM has been assembled and adjusted with a high degree of precision; avoid applying excessive shocks to the module or making any alterations or modifications to it.

- ◆ Do not alter, modify or change the shape of the tab on the metal frame.
- ◆ Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- ◆ Do not damage or modify the pattern writing on the printed circuit board.
- ◆ Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- ◆ Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- ◆ Do not drop, bend or twist Display Future LCM.

III.4 Electro-Static Discharge Control

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

- ◆ Make certain that you are grounded when handling LCM.
- ◆ Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
- ◆ When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
- ◆ When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- ◆ As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
- ◆ To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

III.5 Precaution for Soldering to Display Future LCM

- ◆ Observe the following when soldering lead wire, connector cable and etc. to the LCM.

-Soldering iron temperature : $280^{\circ}\text{C} \pm 10^{\circ}\text{C}$

-Soldering time: 3-4 sec.

-Solder: eutectic solder.

If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

- ◆ When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- ◆ When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

III.6 Precaution for Operation

- ◆ Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.
- ◆ Driving the Display Future LCD in the voltage above the limit shortens its life.
- ◆ Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
- ◆ If Display Future display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- ◆ Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C, 50% RH.
- ◆ When turning the power on, input each signal after the positive/negative voltage becomes stable.

III.7 Limited Warranty

Unless agreed between Display Future and customer, Display Future will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Display Future LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to Display Future within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of Display Future limited to repair and/or replacement on the terms set forth above. Display Future will not be responsible for any subsequent or consequential events.

III.8 Return Policy

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are:

- Broken LCD glass.
- PCB eyelet damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- Soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet's, conductors and terminals

That's the end of the datasheet